



Instituto Superior
Técnico
University of Lisbon
July 24-27, 2018
Lisbon, Portugal
ictws2018.ist.utl.pt

Lisbon, April 30, 2018

Subject: Letter of Invitation for Prof. Zhichao Lai (ID card number: 350500198611055574)

To whom it may concern,

I am writing this letter to invite Professor Zhichao Lai (ID card number: 350500198611055574), from Fuzhou University, to attend the upcoming *Eighth International Conference on Thin-Walled Structures* (ICTWS 2018), which will take place in Lisbon, Portugal, on July 24-27 2018. During ICTWS 2018, Professor Zhichao Lai will present the paper entitled "Pushing the envelope of circular composite column design using high strength materials", which will also been accepted for inclusion in the conference proceedings.

I take the opportunity to inform you that Professor Zhichao Lai has told me that he will use his own research funds to cover all the expenses concerning this trip, namely (i) the ICTWS2018 registration fee, (ii) the traveling expenses (including the flight tickets) and (iii) the expenses associated with accommodation and meals during his stay in Lisbon. Moreover, I would like also to inform you that the technical programme of the conference will comprise three full days (morning and afternoon) and will take place on 25th, 26th and 27th of July, 2018. On the afternoon of 24th of July there will be an early registration period – it is advisable to register during this period, in order to avoid the very busy period of the early morning of 25th of July.

Warmest regards

Yours sincerely,

Prof. Dinar Camotim

Chair of the ICTWS 2018 Organising Committee
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